

Innovative Electronics

Design and Development Services

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Company Overview

- Contract Developer
 - From Concept Study to Series Production
 - Electronic design, review / 2nd opinion, development and **miniaturisation**
 - Industrial including ATEX, Medical and Space
- Established 1999
 - Spin-off (ETH, Zurich)
 - Privately owned (100%)
 - 15 employees
- ISO9001 and ISO13485
 - Medical devices & active medical implants



Design & Consultancy Services

- Research & technology studies
- Review services
 - design review
 - second opinion
 - troubleshooting
- HW and SW system development
- Production set-up and support
- Support for start-up companies and universities



Core Expertise

- System miniaturisation
- Analogue and digital electronics
- Low power electronics
- Power management
- Cryptography and data security
- High and low level embedded software
- High reliability
- Harsh environments (ATEX, space, medical)
- Standard and special technologies
 - SMD, HDP, 3D-MID
 - chip size packages, chip-on-chip
 - bare dies with wire bonding
 - flip-chip, TAB



Typical Applications



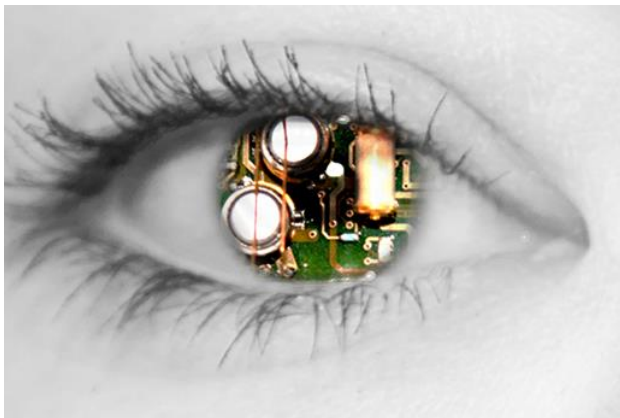
Data Communications & Data Security



Industrial



Medical Devices & Active Implants



Optical Systems



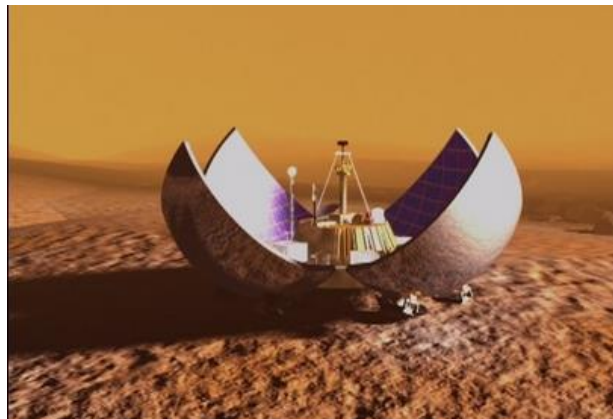
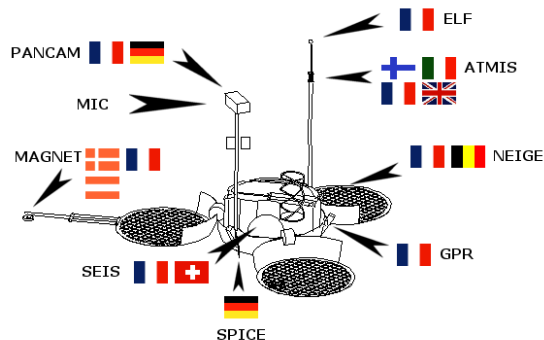
Space



High Reliability & Harsh Environments

Space: NETLANDER™

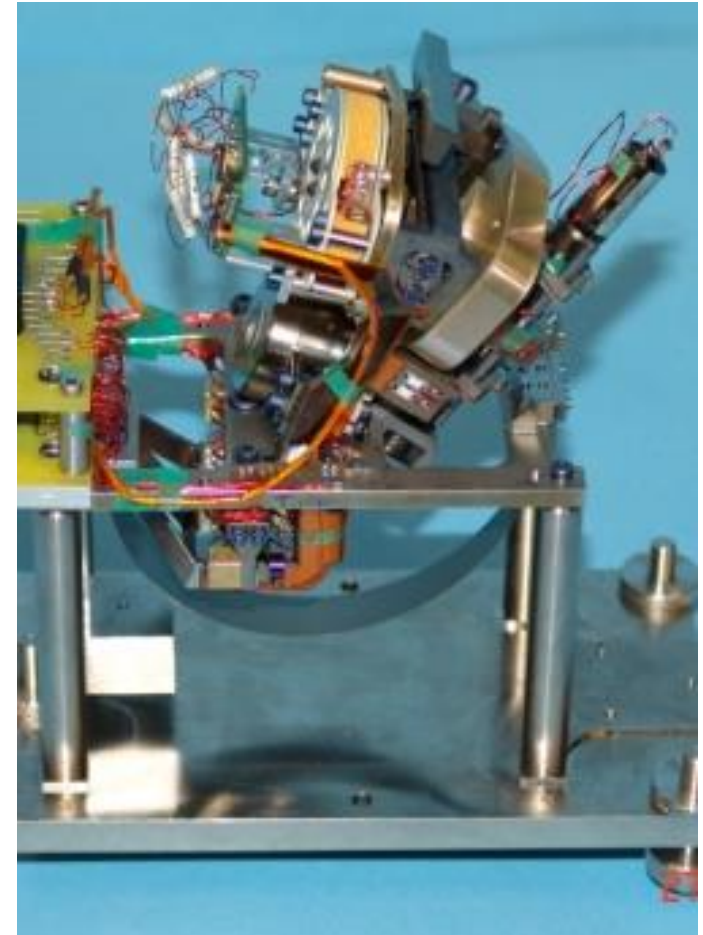
- Mars Landing Probe (2001)
 - Network of four identical landers performing simultaneous measurements in order to study the internal structure of Mars, its sub-surface and its atmosphere.
- Two SEISmometers to study tremors on Mars and locate reservoirs of water or ice
 - very broad band (2-axis)
 - short period (3-axis)



Space: NETLANDER™ - SEIS

- **SEISmometer Electronics**
 - Feasibility study and technology evaluation of main and auxiliary controllers and motor drive electronics

- **SEIS-MC and SEIS-AC modules**
 - system analysis & critical properties review
 - evaluate high density packaging technologies
 - identify ASIC technology for (digital) circuits
 - review miniaturisation potential
 - check availability of components
 - analyse FM development & qualification costs



Space: POLAR

- Detection of Gamma Ray Bursts (GRBs)
- Highly sensitive detector using Compton Scattering Effect to measure polarisation of incoming photons
- Concept to FM (2008 - 2014)
 - swiss experiment (ISDC, Univ. of Geneva)
 - scheduled for two to three years operation
 - only non-Chinese experiment on Tiangong-2
 - launched on 15th September 2016

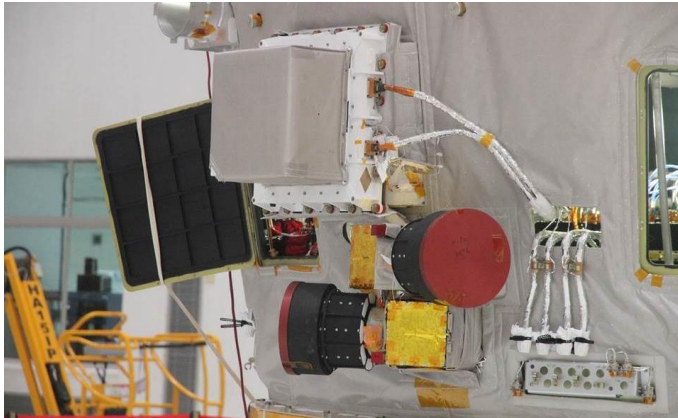


Space: POLAR

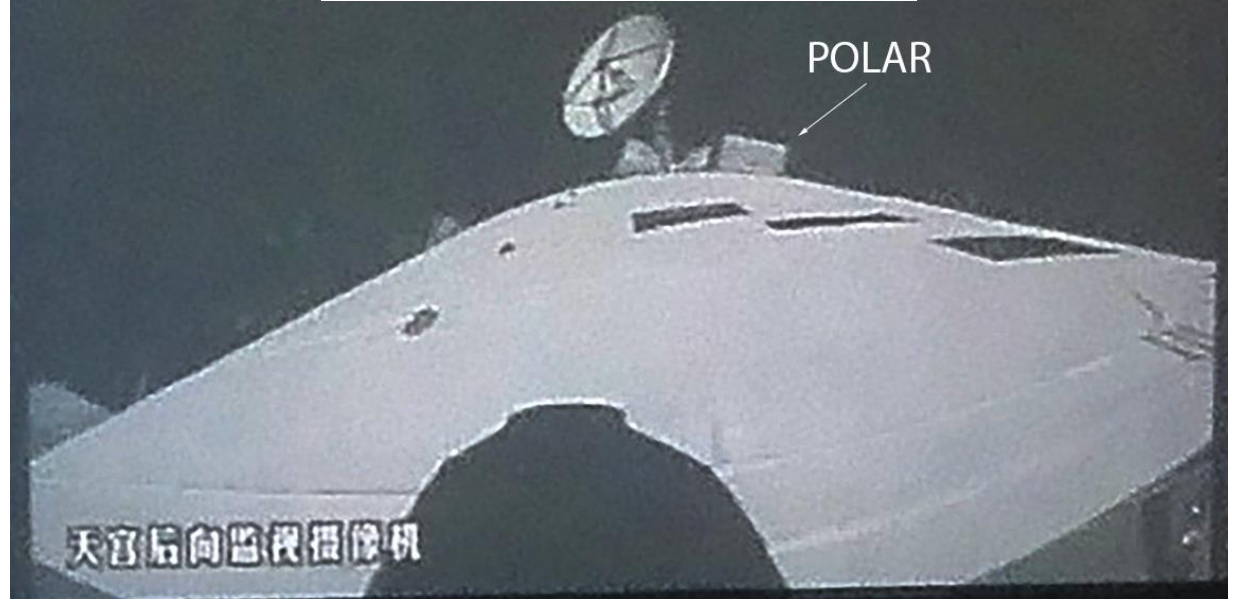
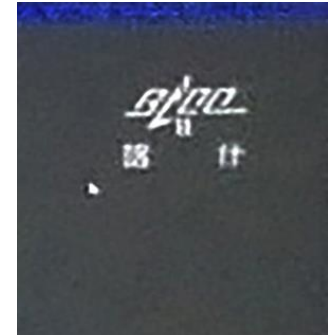
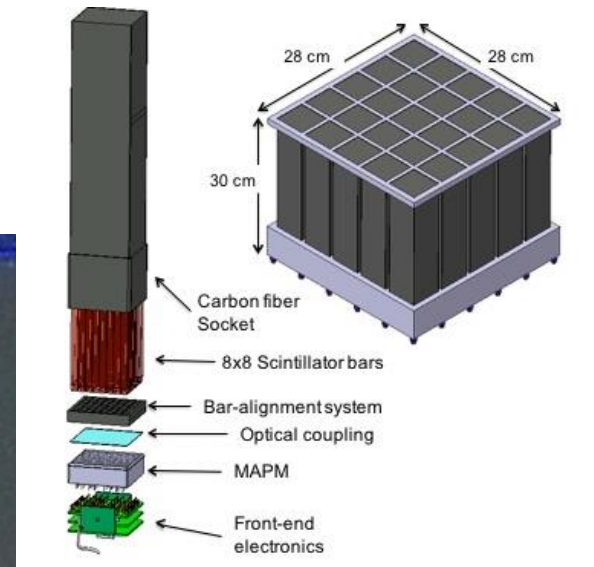
- Feasibility Study
 - evaluate design of existing front end electronics
 - identify potential design errors or weaknesses
 - provide recommendations to increase reliability of manufacturing and overall system.
- High Voltage Power Supply (HVPS)
 - system reverse engineering from breadboard
 - system re-design, development and manufacture
 - 26 settable power sources (on 3 prints)
 - 300 - 500 components per board (300mm x 60mm, 6 layers)
- Low Voltage Power Supply (LVPS)
 - system feasibility study, design, development and manufacture
 - 82 switchable power sources (2 prints)
 - 800 - 1'300 components per board (300mm x 60mm, 8 layers)
- Component procurement and production of EQM, QM's and FM
 - (at customers choice of manufacturers)
- Support qualification and acceptance tests including EMC



Space: POLAR

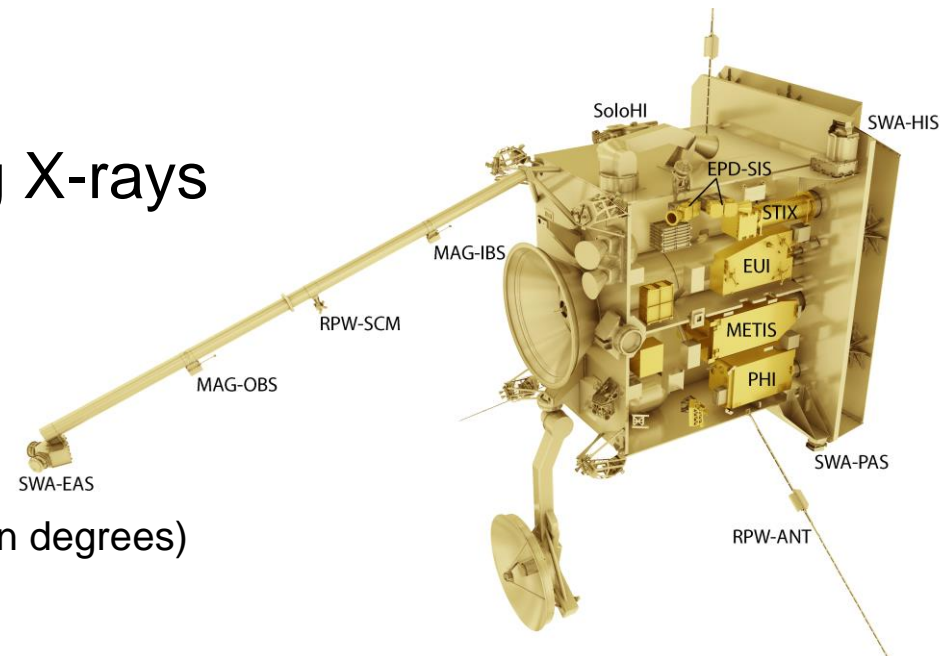


60FPS 6025 fps
116 kbps 8 drop

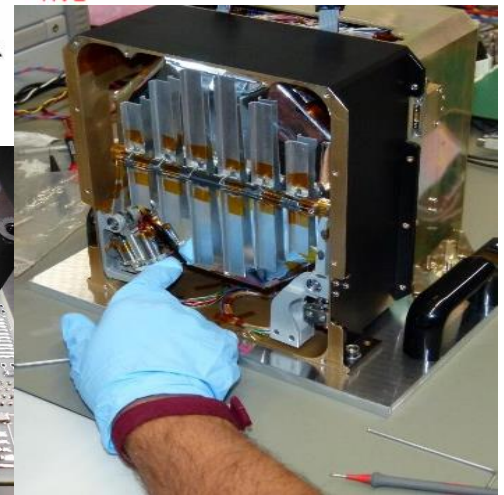
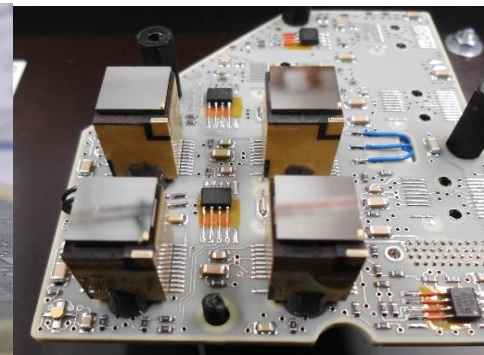
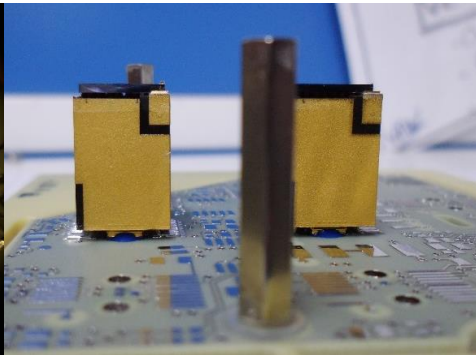
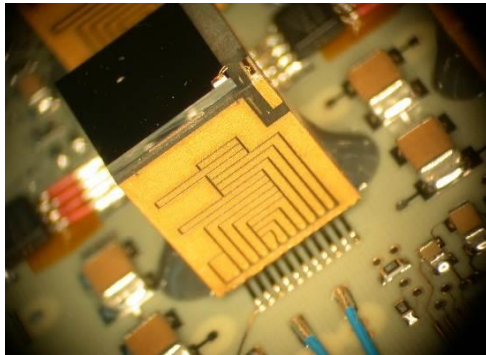
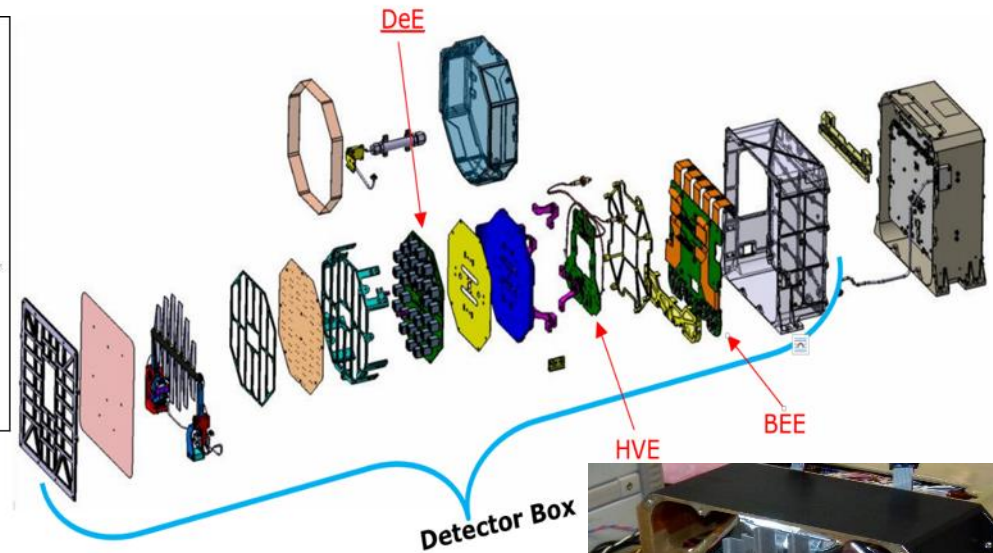
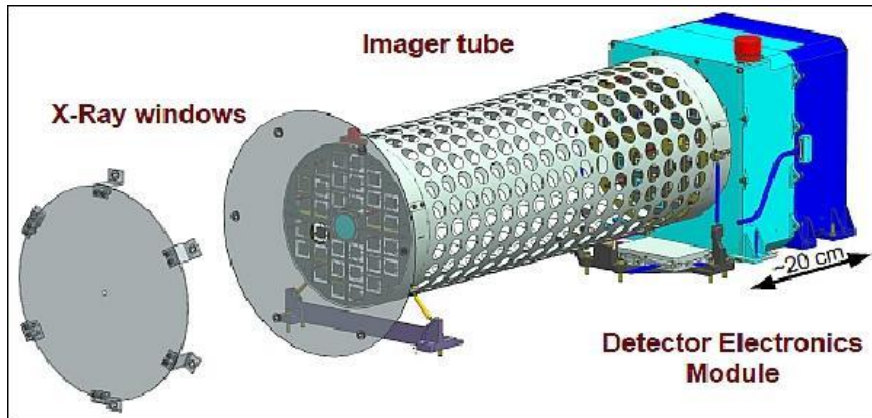


Space: STIX

- Solar Orbiter (launch scheduled 2019)
 - explore how sun creates & influences heliosphere
 - understand risks caused by space weather
- Spectrometer Telescope Imaging X-rays
 - Swiss experiment (FHNW)
 - create images & spectra
 - thermal & non-thermal x-rays
 - time, location, intensity & spectra
 - accelerated electrons
 - high temperature plasma (>10 million degrees)

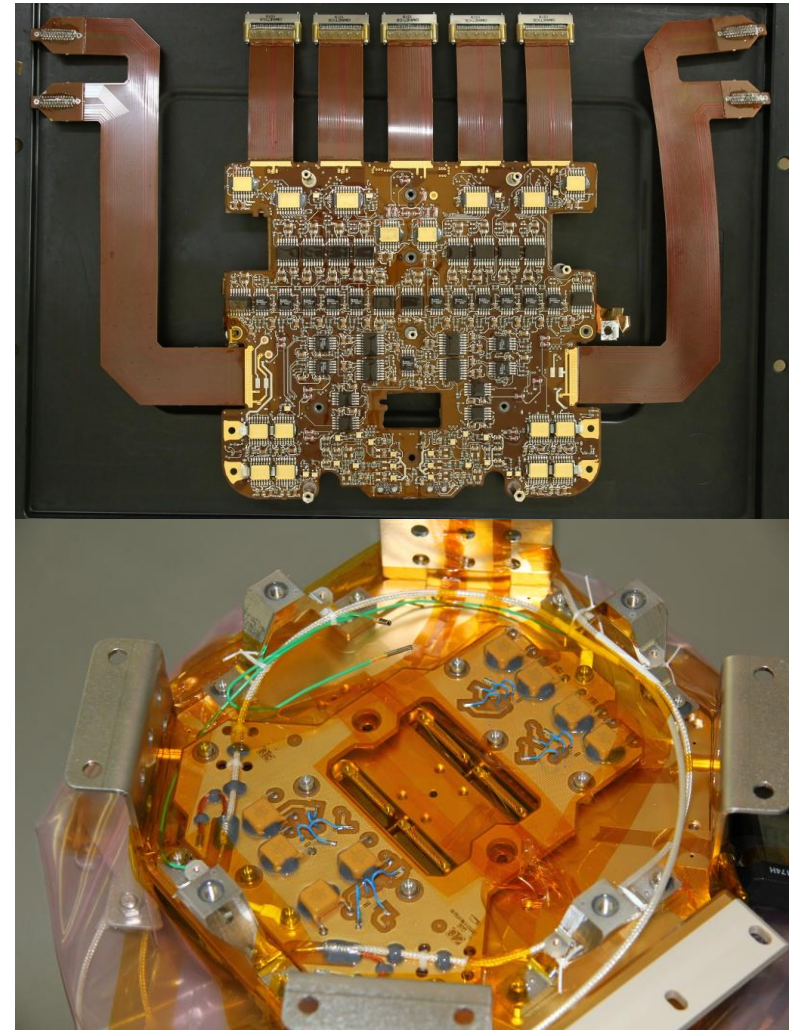


Space: STIX



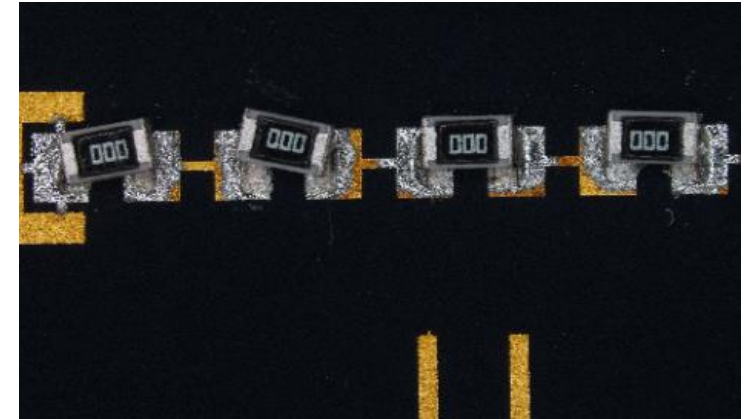
Space: STIX

- Support System Design
 - Interface to IDPU and PSU
 - Interface to attenuator mechanism
- Detector Electronic Board
 - Design, Development & Test
 - 2 W total thermal power
- High Voltage Electronic Board
 - Design, Development & Test of filter and distribution network
- Backend Electronic Board
 - Design, development & Test: Sensor Interface, Attenuator Driver
 - Minimize thermal conduction
- Support Instrument Integration and Test
 - Integration and test procedures
 - EMC, radiation, shock & vibration: qualification and acceptance tests



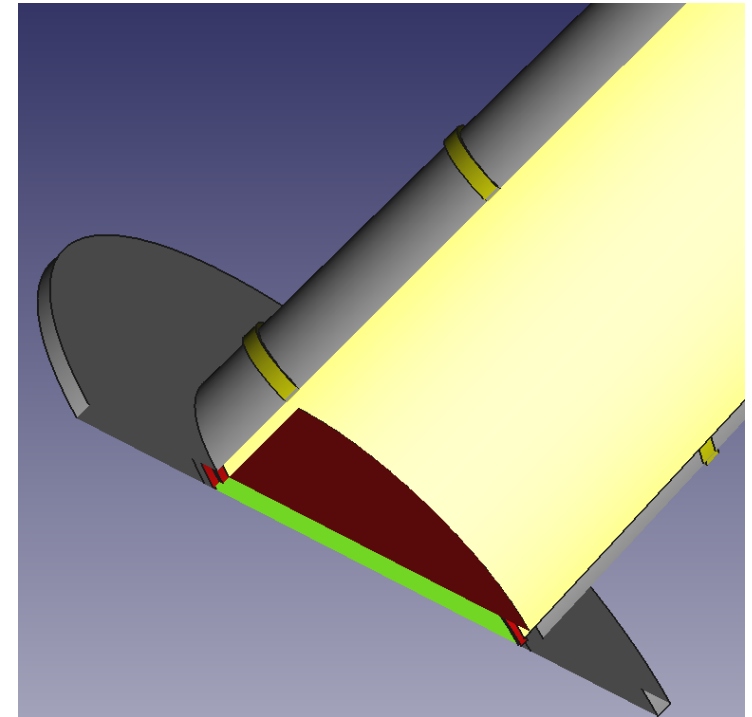
Space: 3D-MID4space (ARTES 5.1)

- Characterise suitability of 3D-MID technologies, manufacturing techniques, processes and materials for space telecom applications... target TRL5
- Identify critical issues & recommendations, or modifications that may be required, lessons learned and conclusions
- Design, build and characterize test samples demonstrator applications
 - Mechanical Properties
 - Tensile Strength
 - Adhesion (Hot Pin Pull, Shear, Bond Wire Pull)
 - RF Properties
 - Resistance / Isolation
- Propose possible follow on activities and road map to increase TRL



Space: 3D-MID4space Helix Antenna

- Quite huge dimensions
($l=165\text{mm}$) for injection moulding
- Challenging construction
 - “constant” wall thickness
 - No seams in metallised area
- Challenging metallisation
 - Need to rotate and shift the body for laser structuring
 - Need for hatched base plate structure

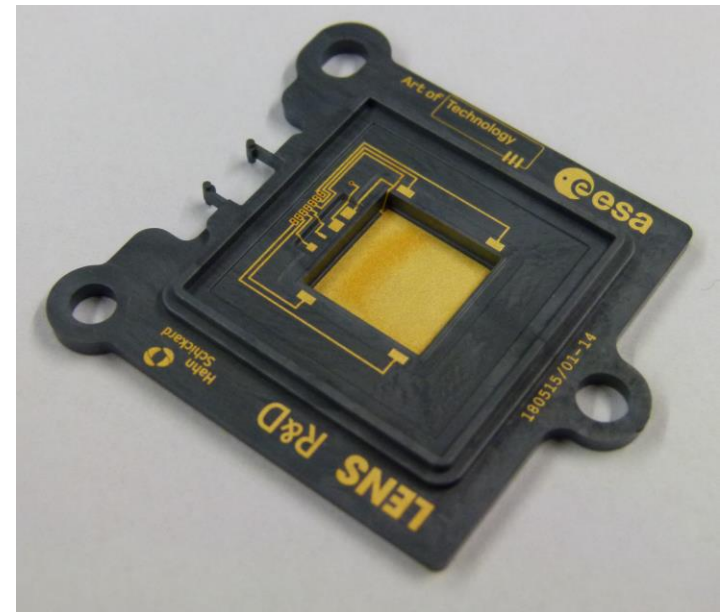
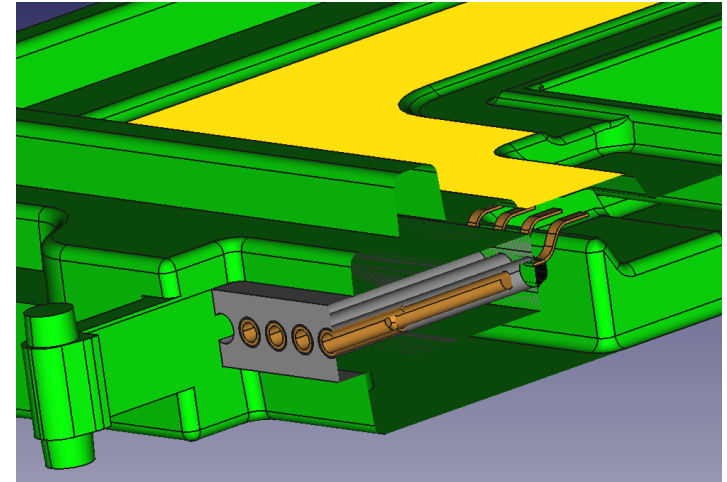


Selected solution:

- Constant wall thickness
- No seams
- But 2 (simple) parts which need to be soldered

Space: 3D-MID4space Sun Sensor

- Single piece injection moulded case
 - Simple moulding tool (2 pieces)
 - “Constant” wall thickness
 - Restrictions for laser writing of metallised tracks
 - Field Of View to be defined by case to avoid window alignment
- Standard connector
 - Directly inserted in mould tool before case moulding
 - Pins completely covered by plastics, electrical connections provided by laser drilled vias to tracks
 - Connector lock using hooks instead of screws
- Assembly
 - SMT mounting / soldering (resistor)
 - Die and wire bonding (4 quadrant diode, thermistor)



Active Medical Implants

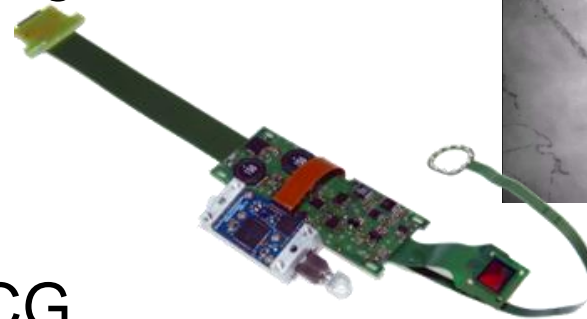
- Ascites suction pump
 - pressure, temperature & motion sensors
 - wireless data transfer & re-charging
 - fully sterilisable
 - <100 grams
 - lifetime > 2 years, > 2000 l fluid

- Long Bone Lengthening Device
 - fully encapsulated motorised part
 - totally biocompatible mobile systems
 - bi-directional transmission of data
 - wireless power transfer from control box to implant



Medical Devices

- Medical camera system
 - high resolution digital imaging with illumination
- Wearable device(s)
 - pulse, skin temperature, ECG
 - movement (and helplessness)
 - blood glucose, blood pressure, SpO2
 - wireless data transfer, alarm button, GSM




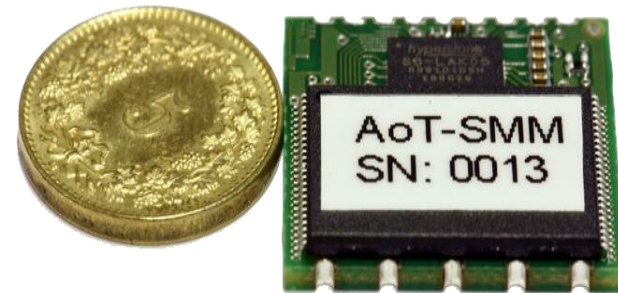
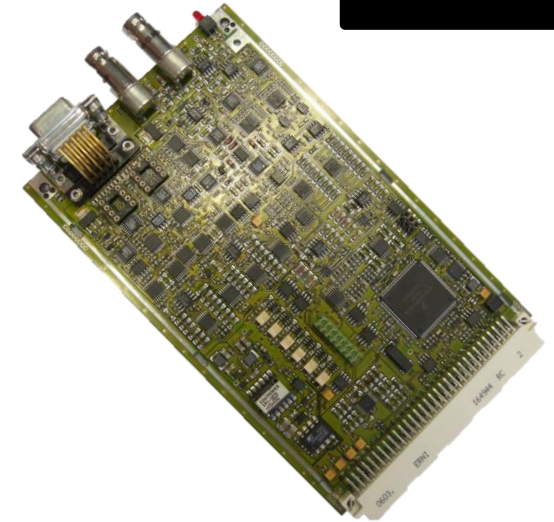
Scientific: ETH Permasense

- Permafrost Monitoring: in 6 months from prototype to small series
- Support for ~25 Sensors
 - temperatures, conductivity, gap distance, ice pressure, water pressure
 - Measurement interval 1-60 min
- Extreme environmental conditions
 - -40 to $+65^{\circ}\text{C}$, $\Delta T \leq 5^{\circ}\text{C/min}$
 - rock fall, ice, frost, avalanches, lightning
- Data transmission nearly in real-time
- Long time stable & reliable
 - $\geq 99\%$ data yield
 - 3 years autonomous operation



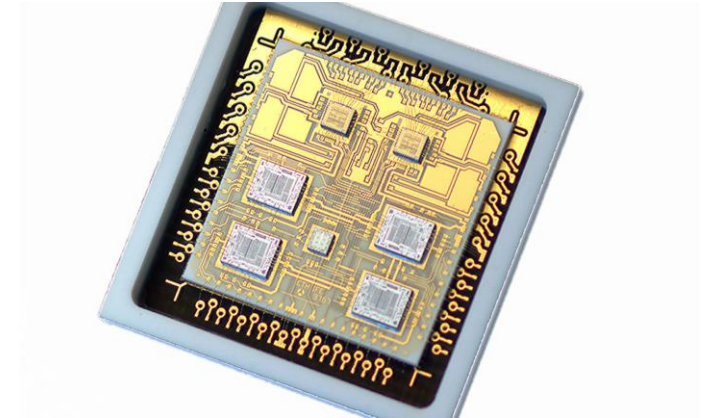
Industrial

- General purpose voltage amplifier
- Optical temperature measurement
- High EMV environment
Small & Low Power
 - Sensor/Logger: $\Phi 9.6 \times 40\text{mm}$, 2 years from coin cell
- Power modules
-  Intrinsic safe electronics for potentially explosive environments
 - GSM / BT / 802.15.4 / NFC Communication
 - Solar Charger
 - GPS Position Detection
 - Ultrasonic Sensor
- Solderable Memory Module (SMM)
 - high vibration environment
 - SD/MMC compatible interface



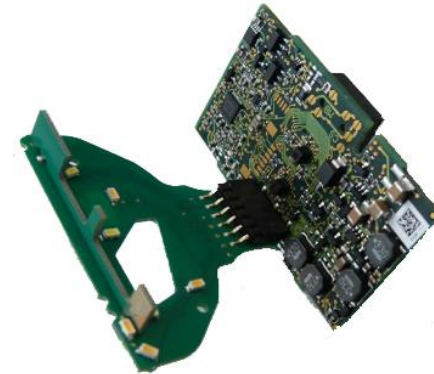
Data Communications

- Wireless communication
 - ISM 433 MHz, 868 MHz, 2.4 & 5 GHz
 - GSM, GPRS, LTE
 - Bluetooth, Bluetooth LE
 - RFID, NFC, WLAN
 - Satellite up to 12 GHz, 77 GHz (terrestrial)
- Wired Communication
 - Data over Supply (DoS)
 - Ethernet, USB
 - Field-Bus, Profi-Bus, M-Bus, HART



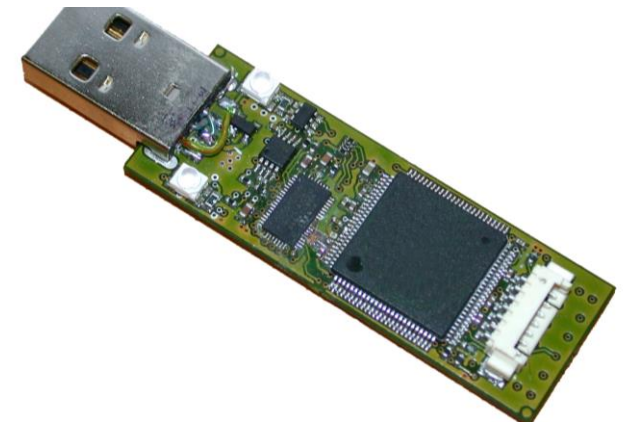
Optical Systems

- 3D-MID camera system
- Industrial
 - IP65 water meter, 2 cameras
 - RFID reader for label data
- Consumer
 - 360° panoramic ball camera
 - 36 cameras, simultaneous trigger



Data Security

- Uni-directional Network Link
 - authentication, authorisation
 - privacy (encryption)
- Secure USB Stick
 - encryption on stick
 - smart card and password
 - small embedded processor
 - strong encryption algorithm



Possible AoT Contribution to SKA

- Review / 2nd opinion
 - Support Contractor Qualification
 - Electronic System Design Review
- Electronic Design
 - Experience with University/Science Customers: POLAR, STIX (Astrophysics), ETH Permasense (Environmental Sciences), ...
 - Experience in Harsh Environment (Space, Deep Sea, Alpine: in particular Temperature Range and Transients)
 - Experience in Low Noise (STIX instrument declared EMC Quiet) and Low Power
- Production & Test
 - Volumes from Samples/Small Series to Mass Production
 - Either selected by Art of Technology or by Customer